

CD4069UBC Inverter Circuits

General Description

The CD4069UB consists of six inverter circuits and is manufactured using complementary MOS (CMOS) to achieve wide power supply operating range, low power consumption, high noise immunity, and symmetric controlled rise and fall times.

This device is intended for all general purpose inverter applications where the special characteristics of the MM74C901, MM74C907, and CD4049A Hex Inverter/Buffers are not required. In those applications requiring larger noise immunity the MM74C14 or MM74C914 Hex Schmitt Trigger is suggested.

All inputs are protected from damage due to static discharge by diode clamps to V_{DD} and V_{SS} .

Features

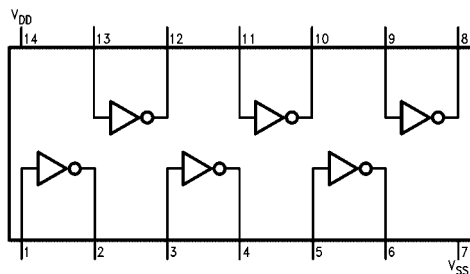
- Wide supply voltage range: 3.0V to 15V
- High noise immunity: 0.45 V_{DD} typ.
- Low power TTL compatibility: Fan out of 2 driving 74L or 1 driving 74LS
- Equivalent to MM74C04

Ordering Code:

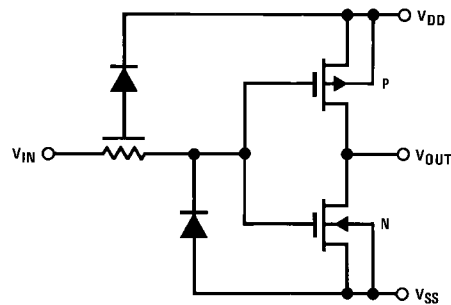
Order Number	Package Number	Package Description
CD4069UBCM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
CD4069UBCSJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
CD4069UBCN	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix "X" to the ordering code.

Connection Diagram



Schematic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

DC Supply Voltage (V_{DD})	–0.5V to +18 V_{DC}
Input Voltage (V_{IN})	–0.5V to V_{DD} +0.5 V_{DC}
Storage Temperature Range (T_S)	–65°C to +150°C
Power Dissipation (P_D)	
Dual-In-Line	700 mW
Small Outline	500 mW
Lead Temperature (T_L)	
(Soldering, 10 seconds)	260°C

Recommended Operating Conditions (Note 2)

DC Supply Voltage (V_{DD})	3V to 15 V_{DC}
Input Voltage (V_{IN})	0V to V_{DD} V_{DC}
Operating Temperature Range (T_A)	–55°C to +125°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Recommended Operating Conditions" and Electrical Characteristics table provide conditions for actual device operation.

Note 2: V_{SS} = 0V unless otherwise specified.

DC Electrical Characteristics (Note 3)

Symbol	Parameter	Conditions	–55°C		+25°C			+125°C		Units
			Min	Max	Min	Typ	Max	Min	Max	
I_{DD}	Quiescent Device Current	$V_{DD} = 5V$, $V_{IN} = V_{DD}$ or V_{SS} $V_{DD} = 10V$, $V_{IN} = V_{DD}$ or V_{SS} $V_{DD} = 15V$, $V_{IN} = V_{DD}$ or V_{SS}		0.25 0.5 1.0			0.25 0.5 1.0		7.5 15 30	μA
V_{OL}	LOW Level Output Voltage	$ I_O < 1 \mu A$ $V_{DD} = 5V$ $V_{DD} = 10V$ $V_{DD} = 15V$		0.05 0.05 0.05		0 0 0	0.05 0.05 0.05		0.05 0.05 0.05	V
V_{OH}	HIGH Level Output Voltage	$ I_O < 1 \mu A$ $V_{DD} = 5V$ $V_{DD} = 10V$ $V_{DD} = 15V$	4.95 9.95 14.95		4.95 9.95 14.95	5 10 15		4.95 9.95 14.95		V
V_{IL}	LOW Level Input Voltage	$ I_O < 1 \mu A$ $V_{DD} = 5V$, $V_O = 4.5V$ $V_{DD} = 10V$, $V_O = 9V$ $V_{DD} = 15V$, $V_O = 13.5V$		1.0 2.0 3.0			1.0 2.0 3.0		1.0 2.0 3.0	V
V_{IH}	HIGH Level Input Voltage	$ I_O < 1 \mu A$ $V_{DD} = 5V$, $V_O = 0.5V$ $V_{DD} = 10V$, $V_O = 1V$ $V_{DD} = 15V$, $V_O = 1.5V$	4.0 8.0 12.0		4.0 8.0 12.0			4.0 8.0 12.0		V
I_{OL}	LOW Level Output Current (Note 4)	$V_{DD} = 5V$, $V_O = 0.4V$ $V_{DD} = 10V$, $V_O = 0.5V$ $V_{DD} = 15V$, $V_O = 1.5V$	0.64 1.6 4.2		0.51 1.3 3.4	0.88 2.25 8.8		0.36 0.9 2.4		mA
I_{OH}	HIGH Level Output Current (Note 4)	$V_{DD} = 5V$, $V_O = 4.6V$ $V_{DD} = 10V$, $V_O = 9.5V$ $V_{DD} = 15V$, $V_O = 13.5V$	–0.64 –1.6 –4.2		–0.51 –1.3 –3.4	–0.88 –2.25 –8.8		–0.36 –0.9 –2.4		mA
I_{IN}	Input Current	$V_{DD} = 15V$, $V_{IN} = 0V$ $V_{DD} = 15V$, $V_{IN} = 15V$		–0.1 0.1		-10^{-5} 10^{-5}	–0.1 0.1		–1.0 1.0	μA

Note 3: V_{SS} = 0V unless otherwise specified.

Note 4: I_{OH} and I_{OL} are tested one output at a time.

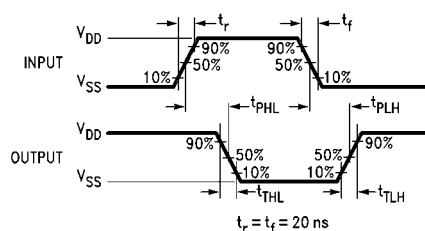
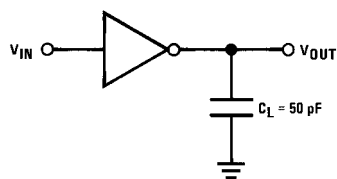
AC Electrical Characteristics (Note 5)

$T_A = 25^\circ\text{C}$, $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$, t_r and $t_f \leq 20\text{ ns}$, unless otherwise specified

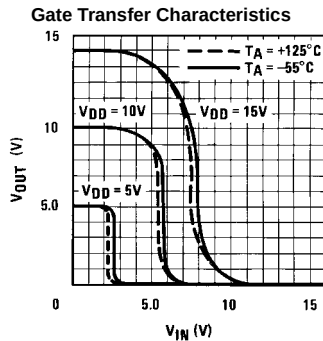
Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{PHL} or t_{PLH}	Propagation Delay Time from Input to Output	$V_{DD} = 5\text{V}$ $V_{DD} = 10\text{V}$ $V_{DD} = 15\text{V}$		50 30 25	90 60 50	ns
t_{THL} or t_{TLH}	Transition Time	$V_{DD} = 5\text{V}$ $V_{DD} = 10\text{V}$ $V_{DD} = 15\text{V}$		80 50 40	150 100 80	ns
C_{IN}	Average Input Capacitance	Any Gate		6	15	pF
C_{PD}	Power Dissipation Capacitance	Any Gate (Note 6)		12		pF

Note 5: AC Parameters are guaranteed by DC correlated testing.

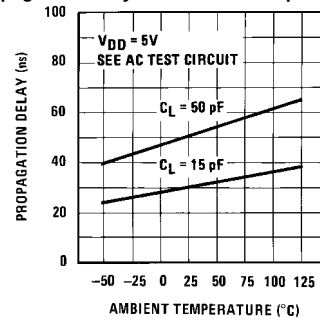
Note 6: C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation, see Family Characteristics application note—AN-90.

AC Test Circuits and Switching Time Waveforms

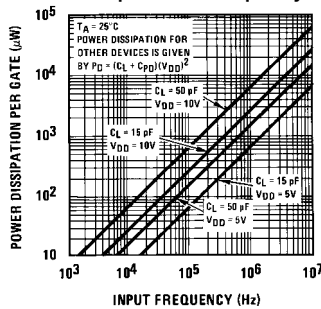
Typical Performance Characteristics



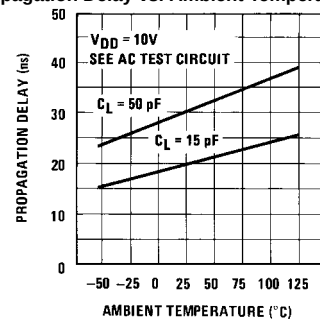
Propagation Delay vs. Ambient Temperature



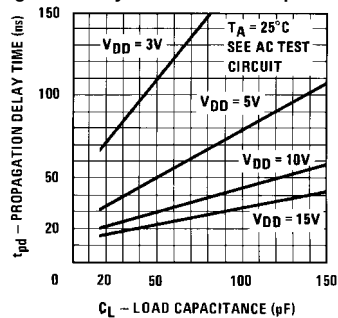
Power Dissipation vs. Frequency

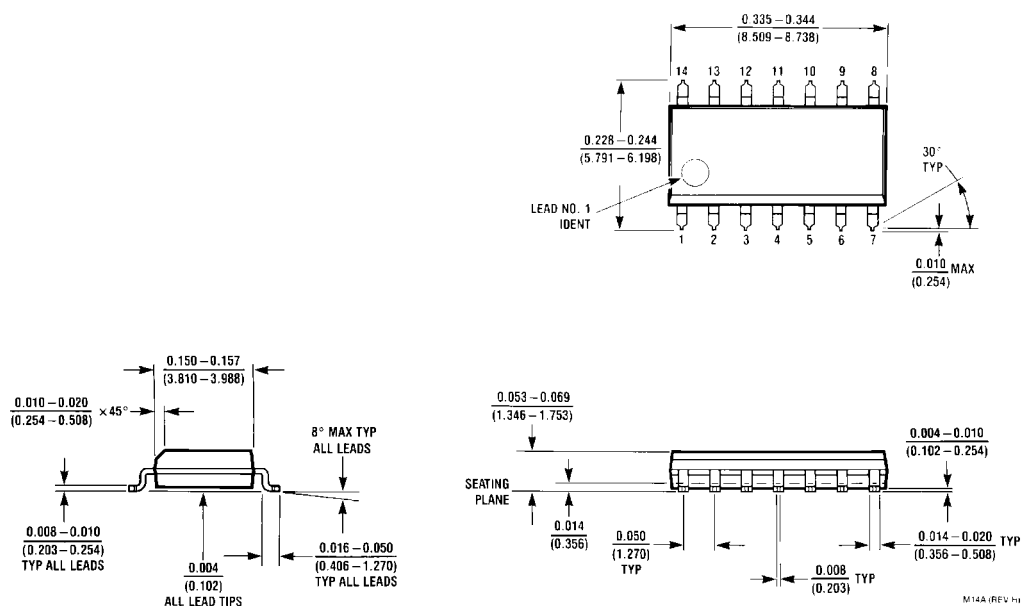


Propagation Delay vs. Ambient Temperature

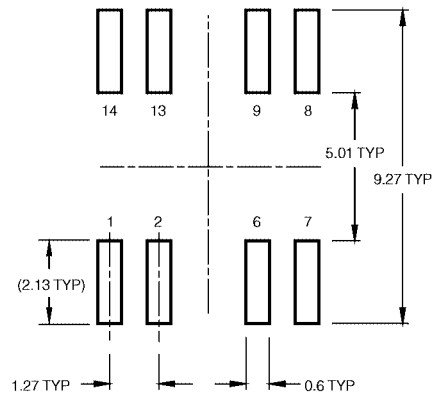


Propagation Delay Time vs. Load Capacitance

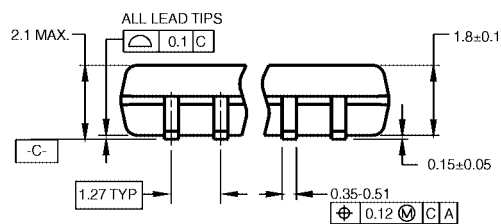


Physical Dimensions inches (millimeters) unless otherwise noted


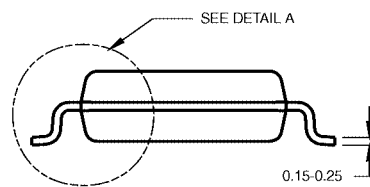
**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M14A**



LAND PATTERN RECOMMENDATION



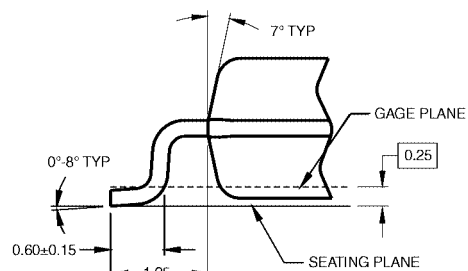
DIMENSIONS ARE IN MILLIMETERS



NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION,
ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
FLASH, AND TIE BAR EXTRUSIONS.

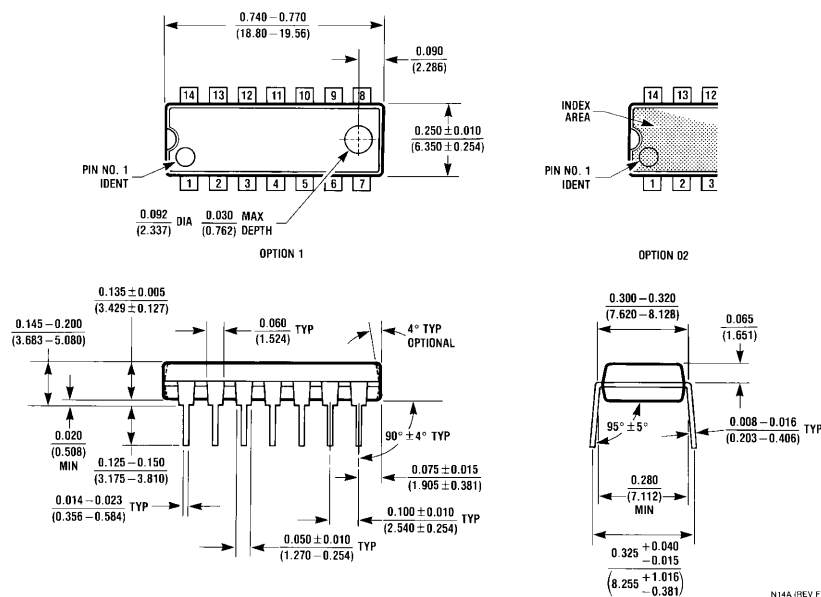
M14DRevB1



DETAIL A

**14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com